

AC7913B8 Datasheet

Zhuhai Jieli Technology Co.,LTD

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AC7913B8 Features

High performance 32-bit RISC CPU

- Double core RISC 32-bit CPU(Support FPU)
- DC-320MHz operation
- 128 Vectored interrupts
- Four Levels interrupt priority

Flexible I/O

- 18 GPIO pins
- All GPIO pins can be programmable as input or output individually
- All GPIO pins are internal pull-up/pull-down selectable individually
- CMOS/TTL level Schmitt triggered input
- External wake up/interrupt on all GPIOs

Peripheral Feature

- FUSB 1.1 OTG controller
- Audio interface supports IIS, left adjusted, right adjusted and DSP mode
- Multi-function 32-bit timers, support capture and PWM mode
- 16-bit PWM generator for motor driving
- Three full-duplex advanced UART
- One SPI interface supports host and device mode
- Two SD Card Host controller and one WIFI SD Card Host controller
- One IIC interface supports host and device mode
- One SPDIF receiving interface without analog amplify
- Quadrate decoder
- Watchdog
- One Crystal Oscillator
- Two channel 16-bit DAC with headphone

amplifier

- Three channels Audio 16-bit ADC
- Three channels MIC amplifier
- Two channels analog MUX
- 10 channels 10-bit ADC
- Power-on reset
- Embedded PMU support low power mode

Bluetooth Feature

- CMOS single-chip fully-integrated radio and baseband
- Compliant with Bluetooth V2.1(BR+EDR)+ BLE V5.3 specification
- Bluetooth Piconet and Scatternet support
- Meet class2 and class3 transmitting power requirement
- Support GFSK and $\pi/4$ DQPSK all packet types
- Provides +15dbm transmitting power
- Receiver with -93dBm sensitivity
- Support a2dp\avctp\avdtp\avrcp\hfp\spp\smp\att\gap\gatt\rfcomm\sdpl2cap profile

WIFI Feature

- Support all mandatory IEEE 802.11b data rates of 1, 2, 5.5 and 11 Mbps, all 802.11g payload data rates of 6, 9, 12, 18, 24, 36, 48 and 54 Mbps, as well as 802.11n MCS0~MCS7, 20MHz/40MHz BW, 800ns and 400ns guard interval.
- Support advanced 1x1 802.11n features:
 - Full / Half Guard Interval
 - Frame Aggregation
 - Reduced Inter-frame Space (RIFS)
 - Space Time Block Coding (STBC)
 - Greenfield mode

- Support WEP/WPA-PSK(TKIP/CCMP)
/WPA2-PSCK/AES256/AES128/SHA256
/SHA128
- Support apply to AP/STA
- Transmitter power:

DSSS 1M/S	17	dBm
MCS0	16	dBm
MCS7	13	dBm
- Receiver sensitivity:

DSSS 1M/S	-95	dBm
MCS0	-92	dBm
MCS7	-74	dBm

Packages

- QFN40(5mm*5mm)

Temperature

- Operating temperature: -40°C to +85°C
- Storage temperature: -65°C to +150°C

1. Pin Definition

1.1 Pin Assignment

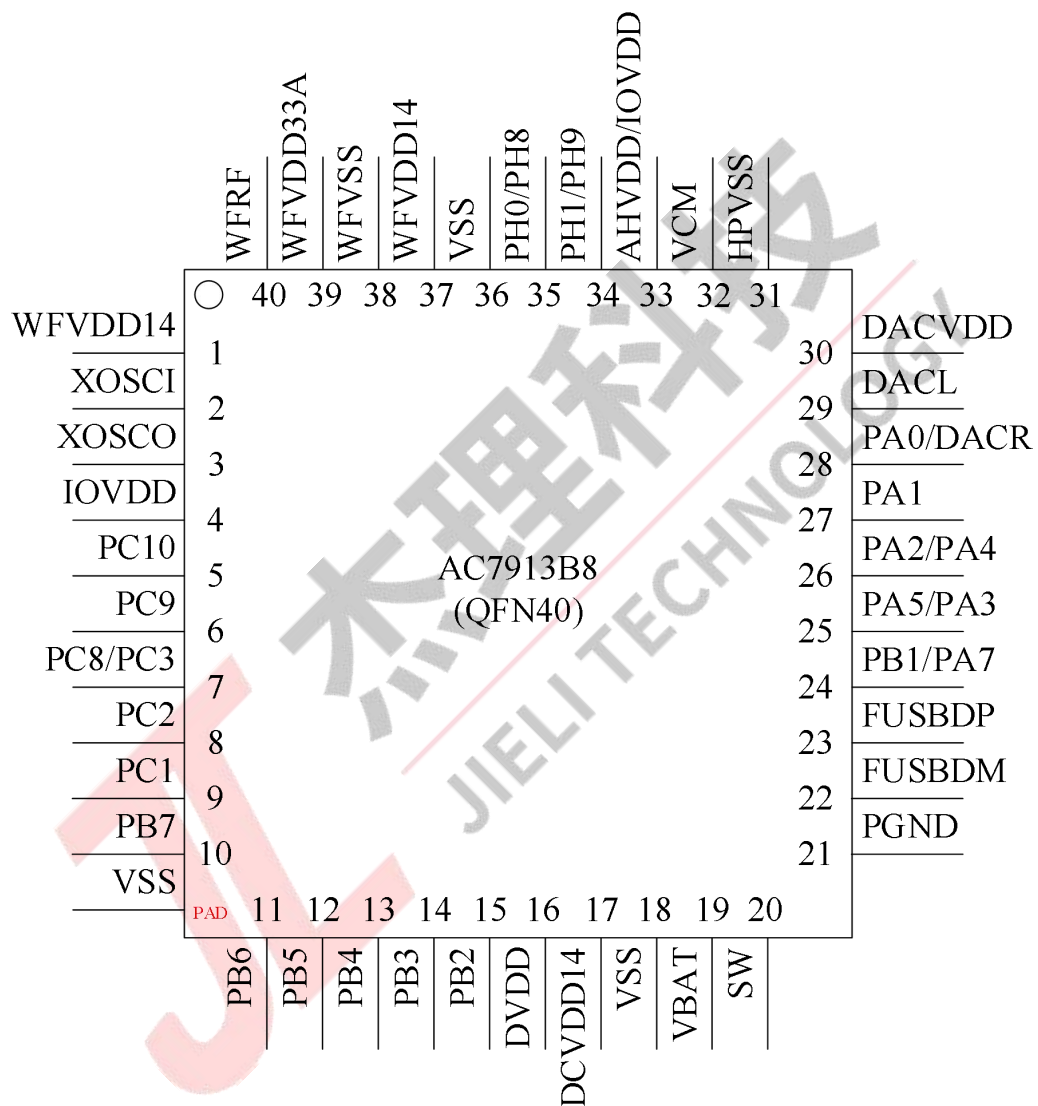


Figure 1-1 AC7913B8_QFN40 Package Diagram

1.2 Pin Description

Table 1-1 AC7913B8_QFN40 Pin Description

PIN NO.	Name	I/O Type	Drive (mA)	Function	Other Function
1	WVDD14	P	/	RF Power 1.4V	-
2	XOSCI	I	/	RF OSCI	-
3	XOSCO	O	/	RF OSCO	-
4	IOVDD	P	/	IO Power 3.3V	-
5	PC10	I/O	24/16/8/2.4	GPIO	SD0_CLKD: SD0 Clock(D) SPI1_DOB: SPI1 Data Out(B) ISP_DI_B Q-decoder1 UART2_RXB: Uart2 Data In(B) ADC9: ADC Channel 9 TMR5CK(MCPWM) PWM3: Timer3 PWM Output TOUCH10: Touch Input Channel 10 SDTAP_DATA
6	PC9	I/O	24/16/8/2.4	GPIO	SD0_CMDD: SD0 CMD(D) SPI1_CLKB: SPI1 Clock(B) ISP_CLK_B Q-decoder0 UART2_TXB: Uart2 Data Out(B) ADC8: ADC Channel 8 TMR4CK(MCPWM) TOUCH9: Touch Input Channel 9 SDTAP_CLKA
7	PC8	I/O	24/16/8/2.4	GPIO	SD0_DAT0D: SD0 Data0(D) SPI1_DIB: SPI1 Data In(B) SPDIF_B PWMCH2L(MCPWM) CAP5: Timer5 Capture TOUCH8: Touch Input Channel 8
	PC3	I/O	24/16/8/2.4	GPIO	UART1_TXB: Uart1 Data Out(B) ALNK0_DAT0A: Audio Link0 Data0(A) ALNK1_DAT0A: Audio Link1 Data0(A) SD1_DAT1B: SD1 Data1(B) FPIN6(MCPWM) TMR4: Timer4 Clock In TOUCH3: Touch Input Channel 3

PIN NO.	Name	I/O Type	Drive (mA)	Function	Other Function
8	PC2	I/O	24/16/8/2.4	GPIO	IIC_SDA_C: IIC SDA(C) ALNK0_LRCKA: Audio Link0 Word Select(A) ALNK1_LRCKA: Audio Link1 Word Select(A) SD1_DAT0B: SD1 Data0(B) PWMCH4L(MCPWM) CAP1: Timer1 Capture TOUCH2: Touch Input Channel 2
9	PC1	I/O	24/16/8/2.4	GPIO	IIC_SCL_C: IIC SCL(C) ALNK0_SCLKA: Audio Link0 Serial Clock(A) ALNK1_SCLKA: Audio Link1 Serial Clock(A) SD1_CLKB: SD1 Clock(B) ADC7: ADC Channel 7 PWM1: Timer1 PWM Output Wakeup11: Port Wakeup 11 TOUCH1: Touch Input Channel 1
10	PB7	I/O	24/16/8/2.4	GPIO	UART1_RTS:Uart1 Receive Bit Stream Control SD0_CLKA: SD0 Clock(A) SPI1_DOA: SPI1 Data Out(A) UART2_RXC: Uart2 Data In(C) ADC5: ADC Channel 5 PWMCH7L(MCPWM) SDTAP_DATC WFSD_CLK: WIFI SD Clock
11	PB6	I/O	24/16/8/2.4	GPIO	UART1_CTS:Uart1 Transmit Bit Stream Control SD0_CMDA: SD0 CMD(A) SPI1_CLKA: SPI1 Clock(A) UART2_TXC: Uart2 Data Out(C) ADC4: ADC Channel 4 PWMCH7H(MCPWM) Wakeup9: Port Wakeup 9 SDTAP_CLKC WFSD_CMD: WIFI SD CMD

PIN NO.	Name	I/O Type	Drive (mA)	Function	Other Function
12	PB5	I/O	8	GPIO	PLNK0_DAT1: PLNK0 Data1 SD0_DAT0A: SD0 Data0(A) PLNK1_DAT1: PLNK1 Data1 SPI1_DIA: SPI1 Data In(A) FPIN2(MCPWM) CAP0: Timer0 Capture WFSD_DAT0: WIFI SD DAT0
13	PB4	I/O	8	GPIO	SD0_DAT1A: SD0 Data1(A) PLNK1_SCLK: PLNK1 Serial Clock UART1_RXC: Uart1 Data In(C) FPIN1(MCPWM) TMR2: Timer2 Clock In WFSD_DAT1: WIFI SD DAT1
14	PB3	I/O	8	GPIO	PLNK0_SCLK: PLNK0 Serial Clock SD0_DAT2A: SD0 Data2(A) UART1_TXC: Uart1 Data Out(C) PWMCH6L(MCPWM) WFSD_DAT2: WIFI SD DAT2
15	PB2	I/O	8	GPIO	PLNK0_DAT0: PLNK0 Data0 SD0_DAT3A: SD0 Data3(A) PLNK1_DAT0: PLNK1 Data0 PWMCH6H(MCPWM) CAP2: Timer2 Capture WFSD_DAT3: WIFI SD DAT3
16	DVDD	P	/	Core Power 1.2V	-
17	DCVDD14	P	/	Core Power 1.4V	-
18	VSS	P	/	Ground	-
19	VBAT	P	/	LDO Power	-
20	SW	P	/	DC-DC Switch Pin	-
21	PGND	P	/	PMU Ground	-
22	FUSBDM	I/O	10	USB Negative Data (pull down)	UART1_RXD: Uart1 Data In(D) ISP_DI_A SPI2_DOB: SPI2 Data Out(B) IIC_SDA_A: IIC SDA(A) ADC12: ADC Channel 12 SDTAP_DATB

PIN NO.	Name	I/O Type	Drive (mA)	Function	Other Function
23	FUSBDP	I/O	10	USB Positive Data (pull down)	UART1_TXD: Uart1 Data Out(D) ISP_CLK_A SPI2_CLKB: SPI2 Clock(B) IIC_SCL_A: IIC SCL(A) ADC13: ADC Channel 13 SDTAP_CLKB
24	PB1	I/O	24/16/8/2.4	GPIO (pull up)	ISP_DO UART0_TXB: Uart0 Data Out(B) ADC3: ADC Channel 3 Long Press reset TMR1: Timer1 Clock In Wakeup8: Port Wakeup 8
	PA7	I/O	24/16/8/2.4	GPIO	SPDIF_C ADC0: ADC Channel 0 PWMCH1H(MCPWM) TMR0: Timer0 Clock In Wakeup3: Port Wakeup 3 SDTAP_CLKD
25	PA5	I/O	24/16/8/2.4	GPIO	UART0_TXA: Uart0 Data Out(A) AMUX2: Simulator Channel 2 CAP3: Timer3 Capture
	PA3	I/O	24/16/8/2.4	GPIO	SPI2_CLKC: SPI2 Clock(C) MIC2P: MIC2 P Channel UART0_TXC: Uart0 Data Out(C) PWMCH0H(MCPWM)
26	PA2	I/O	24/16/8/2.4	GPIO	MIC0P: MIC0 P Channel TMR0CK(MCPWM)
	PA4	I/O	24/16/8/2.4	GPIO	CLKOUT1: Clock Out1 SPI2_DOC: SPI2 Data Out(C) MIC2N: MIC2 N Channel UART0_RXC: Uart0 Data In(C) PWMCH0L(MCPWM)
27	PA1	I/O	24/16/8/2.4	GPIO	MIC0N: MIC0 N Channel PWM0: Timer0 PWM Output
28	PA0	I/O	24/16/8/2.4	GPIO	AMUX0: Simulator Channel 0 TMR1CK(MCPWM) Wakeup2: Port Wakeup 2
	DACR	O	/	DAC Right Channel	-
29	DACL	O	/	DAC Left Channel	-
30	DACVDD	P	/	DAC Power	-
31	HPVSS	P	/	Audio Ground	-

PIN NO.	Name	I/O Type	Drive (mA)	Function	Other Function
32	VCM	P	/	VCM	-
33	AHVDD	P	/	Audio Power	-
	IOVDD	P	/	IO Power 3.3V	-
34	PH1	I/O	24/16/8/2.4	GPIO	IIC_SDA_D: IIC SDA(D) SPI2_DOA: SPI2 Data Out(A) UART0_RXD: Uart0 Data In(D) PWMCH3L(MCPWM) TOUCH12: Touch Input Channel 12
	PH9	I/O	24/16/8/2.4	GPIO	MIC1P: MIC1 P Channel
35	PH0	I/O	24/16/8/2.4	GPIO	IIC_SCL_D: IIC SCL(D) SPI2_CLKA: SPI2 Clock(A) UART0_TXD: Uart0 Data Out(D) ADC10: ADC Channel 10 PWMCH3H(MCPWM) Wakeup12: Port Wakeup 12 TOUCH11: Touch Input Channel 11
	PH8	I/O	24/16/8/2.4	GPIO	MIC1N: MIC1 N Channel
36	VSS	P	/	Ground	-
37	WVDD14	P	/	RF Power 1.4V	-
38	WVSS	P	/	RF Ground	-
39	WVDD33A	P	/	RF Power 3.3V	-
40	WFRF	-	/	RF Antenna	-
PAD		P	/	VSS	-

2. Electrical Characteristics

2.1 Absolute Maximum Ratings

Table 2-1

Symbol	Parameter	Min	Max	Unit
Tamb	Ambient Temperature	-40	+85	°C
Tstg	Storage temperature	-65	+150	°C
VBAT	Supply Voltage	-0.3	5.5	V
WVDD33A	RF Power 3.3V Voltage	-0.3	3.5	V
AHVDD	Audio Power Voltage	-0.3	3.5	V
WVDD14	RF Power 1.4V Voltage	-0.3	1.55	V
V _{3.3IO}	3.3V IO Input Voltage	-0.3	IOVDD+0.3	V

2.2 PMU Characteristics

Table 2-2

Symbol	Parameter	Min	Typ	Max	Unit	Test Conditions
VBAT	Voltage Input	2.2	3.7	5.5	V	—
IOVDD	Voltage output	2.1	3.3	3.5	V	LDO5V = 5V, 200mA loading
DCVDD14	Voltage output	1.2	1.4	1.55	V	LDO mode: 70mA loading DC-DC mode: 120mA loading
DVDD	Voltage output	0.87	1.2	1.32	V	LDO5V=5V, 100mA loading
WVDD33A	Voltage Input	2.1	3.3	3.5	V	—
AHVDD	Voltage Input	2.1	3.3	3.5	V	—
WVDD14	Voltage Input	1.2	1.4	1.55	V	—

2.3 IO Input/Output Electrical Logical Characteristics

Table 2-3

IO input characteristics						
Symbol	Parameter	Min	Typ	Max	Unit	Test Conditions
V_{IL}	Low-Level Input Voltage	-0.3	—	$0.3 \cdot IOVDD$	V	$IOVDD = 3.3V$
V_{IH}	High-Level Input Voltage	$0.7 \cdot IOVDD$	—	$IOVDD + 0.3$	V	$IOVDD = 3.3V$
IO output characteristics						
V_{OL}	Low-Level Output Voltage	—	—	0.33	V	$IOVDD = 3.3V$
V_{OH}	High-Level Output Voltage	2.7	—	—	V	$IOVDD = 3.3V$

2.4 Internal Resistor Characteristics

Table 2-4

Port	General Output	High Drive	Internal Pull-Up Resistor	Internal Pull-Down Resistor	Comment
PA,PC,PD, PH, PB1,PB6, PB7	8mA	24mA	10K	10K	1.PB1 default pull up 2.FUSBDM & FUSBDP default pull down 3. Internal pull-up/pull-down resistance accuracy $\pm 20\%$
PB2-PB5	8mA	—	10K	10K	
FUSBDP FUSBDM	10mA	—	1.5K	15K	

2.5 DAC Characteristics

Table 2-5

Parameter	Min	Typ	Max	Unit	Test Conditions
Frequency Response	20	—	20K	Hz	1KHz/0dB 10Kohm loading With A-Weighted Filter
THD+N	—	-72	—	dB	
S/N	—	99	—	dB	
Crosstalk	—	-90	—	dB	
Output Swing	—	0.9	—	Vrms	
Dynamic Range	—	93	—	dB	1KHz/-60dB 10Kohm loading With A-Weighted Filter
DAC Output Power	15	—	—	mW	32ohm loading

2.6 ADC Characteristics

Table 2-6

Parameter	Min	Typ	Max	Unit	Test Conditions
Dynamic Range	—	87	—	dB	1KHz/-60dB 10Kohm loading With A-Weighted Filter
S/N	—	90	—	dB	1KHz/0dB 10Kohm loading With A-Weighted Filter
THD+N	—	-72	—	dB	
Crosstalk	—	-80	—	dB	

2.7 ESD Protection

Table 2-7

Parameter	Typ.	Test pin	Reference standard
Human Body Mode	±4KV	All pins(except WFRF)	JEDEC EIA/JESD22-A114
Machine Mode	±200V	All pins	JEDEC EIA/JESD22-A115
Charge Device Model	±1KV	All pins	JEDEC EIA/JESD22-C101F
Latch up	±200mA	All GPIO pins	JEDEC STANDARD NO.78E
	1.5xVopmax	All power pins	

Note : 1.5xVopmax = 1.5 times maximum operating voltage.

3. Package Information

3.1 QFN40(5mm*5mm)

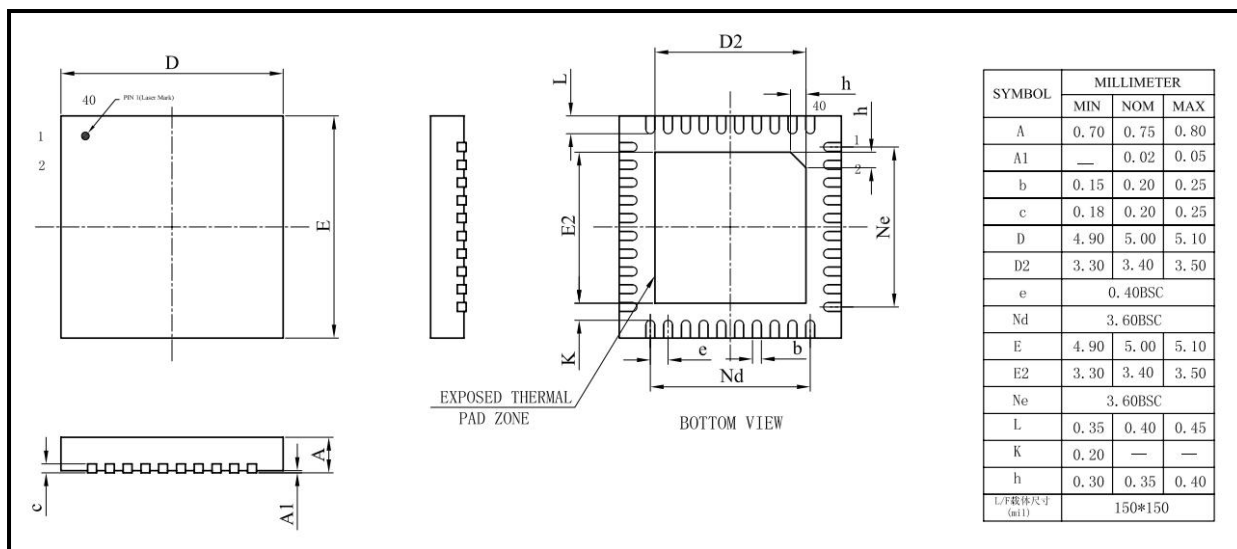
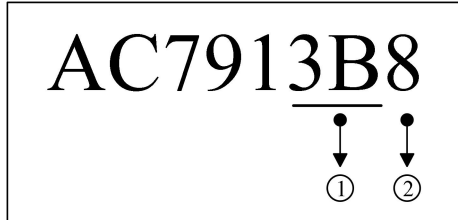


Figure 3-1 AC7913B8_QFN40 Package

4. Package Type Specification



①Represents different chips (different packages or bindings)

AC7913B8 has built-in Flash.

②Represents different memory sizes

0: No memory

2: 2Mbit Flash

4: 4Mbit Flash

8: 8Mbit Flash

6: 16Mbit Flash

3: 32Mbit Flash

5: 64Mbit Flash

7: 128Mbit Flash

A: 1Mx16 SDRAM

B: 4Mx16 SDRAM

C: 16M bit PSRAM

D: 64M bit PSRAM

5. Solder-Reflow Condition

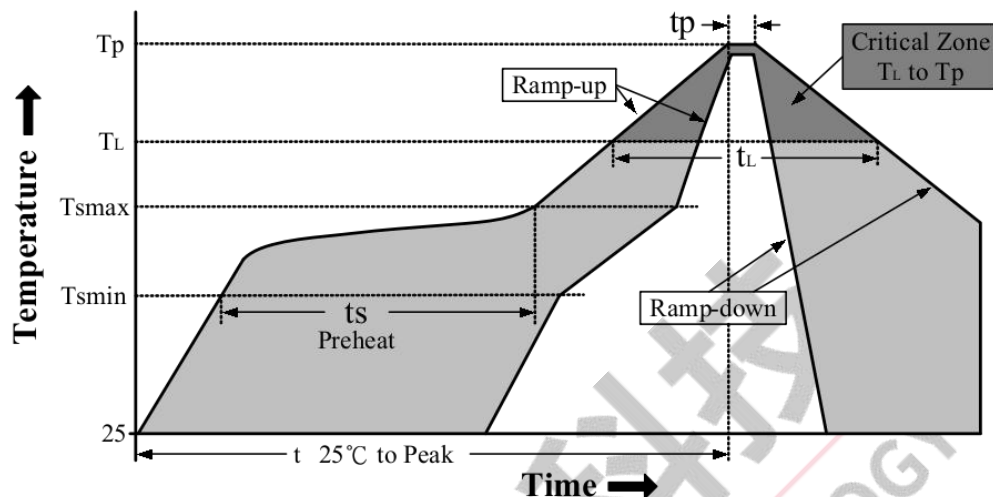


Figure 5-1 Classification Reflow Profile

Classification Profiles

Table 5-1

Profile Feature		Sn-Pb Eutectic Assembly	Pb-Free Assembly
Preheat/Soak	Temperature Min (T_{smin})	100°C	150°C
	Temperature Max (T_{smax})	150°C	200°C
	Time (t_s) from (T_{smin} to T_{smax})	60-120 seconds	60-180 seconds
Average ramp-up rate (T_{smax} to T_p)		3°C/second max	3°C/second max
Liquidous temperature (T_L)		183°C	217°C
Time (t_L) maintained above T_L		60-150 seconds	60-150 seconds
Peak package body temperature (T_p)		See Table 6-2	See Table 6-3
Time within 5°C of actual Peak Temperature (t_p) ²		10-30 seconds	20-40 seconds
Ramp-down rate (T_p to T_L)		6°C/second max	6°C/second max
Time 25°C to peak temperature		6 minutes max	8 minutes max

Note 1: All temperatures refer to topside of the package, measured on the package body surface.

Note 2: Time within 5°C of actual peak temperature (t_p) specified for the reflow profiles is a “supplier” minimum and “user” maximum.

SnPb - Classification Temperature

Table 5-2

Package Thickness	Volume mm ³ < 350	Volume mm ³ ≥ 350
<2.5 mm	240 +0/-5°C	225 +0/-5°C
≥2.5 mm	225 +0/-5°C	225 +0/-5°C

Pb-free - Classification Temperature **Table 5-3**

Package Thickness	Volume mm ³ < 350	Volume mm ³ 350 - 2000	Volume mm ³ > 2000
< 1.6mm	260℃	260℃	260℃
1.6 mm - 2.5mm	260℃	250℃	245℃
> 2.5mm	250℃	245℃	245℃

6. Revision History

Date	Revision	Description
2022.12.12	V1.0	Initial Release

